

About us

Labortechnik Tasler GmbH with its headquarters in Würzburg, Germany, has been developing, producing and selling patented real-time data acquisition systems around the globe for over 20 years.

Through many years of cooperation with its renowned customers from a wide variety of sectors, such as **electric motors, the power industry, mechanical and plant engineering, research and development, aerospace, the automotive industry and the military**, Labortechnik Tasler GmbH has been able to gather relevant experience that has contributed to the development of the **LTTsmart**. The modular concept now makes it possible to assemble the devices individually with different function modules for each customer according to his individual requirements.



Labortechnik Tasler GmbH – fast, flexible and precise measurement technology



Michael Tasler
General Manager

Michael Tasler founded Labortechnik Tasler GmbH based on one of his patents concerning high performance real-time data acquisition systems.

He is a specialist in physics as well as in high performance analog and digital design. He graduated from the University Of Texas at Austin, USA.



WE MEASURE IT ALL

- FLEXIBLE
- FAST
- PRECISE



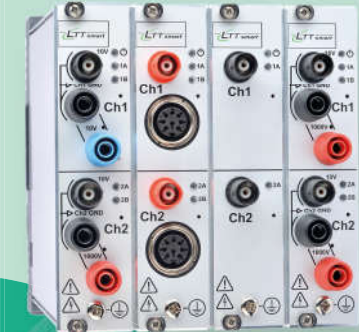
Labortechnik Tasler GmbH

Friedrich-Bergius-Ring 15
97076 Würzburg
Germany

kontakt@tasler.de
+49 931 359 610
www.tasler.de

LTTsmart

Technical Data



- FLEXIBLE
- FAST
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LTTsmart – Technical Data

2-channels per module: High precision data acquisition system incl. analog frontend

Technical Specifications – Optional Specifications marked with *

Specifications are subject to change without notice.

Available per Module

2-Channel high precision data acquisition system with 2 analog inputs:

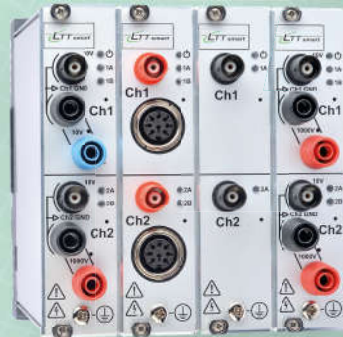
- Synchronously sampling 2 MHz // 24 Bit ADC per channel (optional 4 MHz)
- ± 500 mV, ± 10 V, ± 90 V*
- ± 1000 Vrms*
- Extremely high precision: $\pm(0.015\% \cdot \text{Signal} + 0.015\% \cdot \text{Range})$
- ICP@/IEPE with 4 mA supply*
- Charge input*
- Pulse/Counter Inputs with 1.20 ns resolution*
- Strain-Gauge*
- 2.5 kV galvanic isolation

USB 3.0 Interface, Digital I/O (3.3 V LVCMOS/LVTTL), LinkUp/LinkDown-Sync-Interface to cascade multiple devices

Size: ca. 146 x 31 x 140 mm³ (L x W x H) per module

Input Characteristics

Max. Bandwidth	DC – 900 kHz (optional 1.7 MHz)
Filter	Analog: 900 kHz low-pass filter (optional 1.7 MHz) Digital: a variety of selectable filters
Inter-Channel Phase Difference	≤ 10 ns
Input Connectors	BNC, High Voltage Banana and/or DIN
Galvanic Isolation	2500 VDC
Volt Input Ranges	± 500 mV, ± 10 V, ± 90 V*, ± 1000 Vrms*
Volt Input Impedance	1M Ω _50pF, [10M Ω _5pF at ± 1000 Vrms]*
Volt Input Couplings	single-ended (AC/DC) (AC available only at ± 500 mV and ± 10 V)



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Operation Conditions

Power Supply

- 12-16 VDC (absolute max. rating 10-35 VDC)
- 5 W typical per channel
- external power supply: 100-240 VAC

Environmental Temperature

$+10$ °C to $+30$ °C

Operating System

Windows 7 / 8 / 10, Linux and others

Data Recording

RAM

64 MByte per channel
512 MByte RAM with 8 channels

Interface to PC

USB 3.0, USB 2.0

Recording Media

internal RAM, PC's hard disk

Data Transfer Rates

PC with USB

≥ 170 MByte/s (USB 3.0), 35 MByte/s (USB 2.0)

Input Characteristics

Dynamic Range

	Range	5 kHz	50 kHz	1 MHz
	± 1000 V	110 dB	104 dB	94 dB
	± 90 V	113 dB	107 dB	96 dB
	± 10 V	115 dB	109 dB	98 dB
	± 500 m V	102 dB	94 dB	82 dB

Bandwidth

ENOB (THD+ noise)

Range	effective bits	dB @ 125 kHz sampling rate
± 1000 V	typ 15.3 Bit	-95 dB
± 90 V	typ 15.5 Bit	-96 dB
± 10 V	typ 15.6 Bit	-97 dB
± 500 m V	typ 14.3 Bit	-89 dB

Signal Conditioning

ICP@/IEPE*

Constant current supply: 4 mA. Input coupling: AC and DC

Charge*

1 mV/pC, range: ± 5 nC (optional up to ± 500 nC)
High-pass: 0.15 Hz
auto charge clear; manual clear

Pulse/Counter Input*

Input signal: TTL
Time resolution 1.20 ns (832 MHz)

Strain-Gauge*

Quarter (120 Ω , 350 Ω) / Half / Full Bridges
Constant voltage supply: 0 ... 10 V

Number of Channels

max. No. of Devices

Any number of devices with up to 8 modules each (max. 16 channels per device)

Synchronization

Yes (max. delay between devices: ≤ 20 ns)

External Clock

1 input and 1 output with 3.3 V LVPECL

External Trigger

1 input and 1 output with 3.3 V LVCMOS/LVTTL

Digital in/out

8 inputs and 8 outputs with 3.3 V LVCMOS/LVTTL